

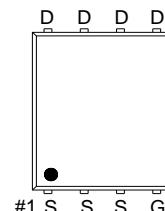
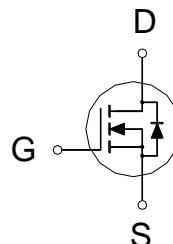
**NIKO-SEM**
**N-Channel Enhancement Mode  
Field Effect Transistor**
**PP4515BK**

PDFN 5x6P

Halogen-Free &amp; Lead-Free

**PRODUCT SUMMARY**

$V_{(BR)DSS}$	$R_{DS(ON)}$	$I_D$
150V	45mΩ	24A


 G. GATE  
 D. DRAIN  
 S. SOURCE
**ABSOLUTE MAXIMUM RATINGS ( $T_A = 25^\circ\text{C}$  Unless Otherwise Noted)**

PARAMETERS/TEST CONDITIONS		SYMBOL	LIMITS	UNITS
Drain-Source Voltage		$V_{DS}$	150	V
Gate-Source Voltage		$V_{GS}$	$\pm 20$	V
Continuous Drain Current	$T_C = 25^\circ\text{C}$	$I_D$	24	A
	$T_C = 100^\circ\text{C}$		17	
Pulsed Drain Current <sup>1</sup>		$I_{DM}$	50	A
Continuous Drain Current	$T_A = 25^\circ\text{C}$	$I_D$	5.3	
	$T_A = 70^\circ\text{C}$		4.4	
Avalanche Current		$I_{AS}$	14	
Avalanche Energy	$L = 1\text{mH}$	$E_{AS}$	74	mJ
Power Dissipation	$T_C = 25^\circ\text{C}$	$P_D$	63	W
	$T_C = 100^\circ\text{C}$		31	
Power Dissipation <sup>3</sup>	$T_A = 25^\circ\text{C}$	$P_D$	3	W
	$T_A = 70^\circ\text{C}$		2.1	
Operating Junction & Storage Temperature Range		$T_j, T_{stg}$	-55 to 175	°C

**THERMAL RESISTANCE RATINGS**

THERMAL RESISTANCE		SYMBOL	TYPICAL	MAXIMUM	UNITS
Junction-to-Ambient <sup>2</sup>	$t \leq 10\text{s}$	$R_{\theta JA}$	°C / W	50	°C / W
Junction-to-Ambient <sup>2</sup>	Steady-State	$R_{\theta JA}$		79	
Junction-to-Case	Steady-State	$R_{\theta JC}$		2.4	

<sup>1</sup>Pulse width limited by maximum junction temperature.<sup>2</sup>The value of  $R_{\theta JA}$  is measured with the device mounted on 1in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with  $T_A = 25^\circ\text{C}$ .<sup>3</sup>The Power dissipation is based on  $R_{\theta JA}$   $t \leq 10\text{s}$  value.

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ELECTRICAL CHARACTERISTICS ( $T_J = 25^\circ\text{C}$ , Unless Otherwise Noted)

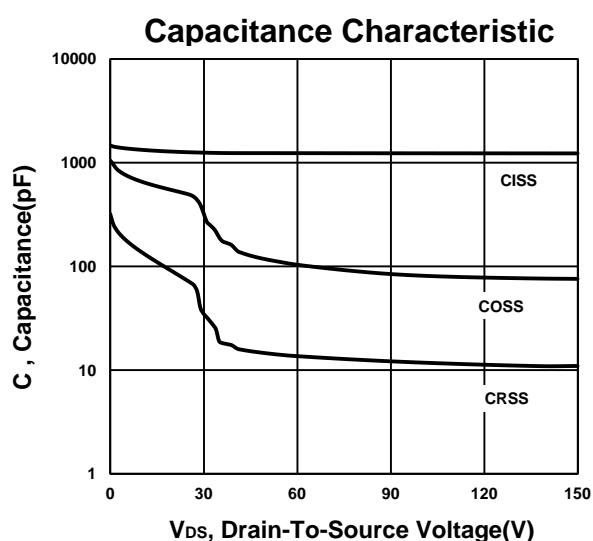
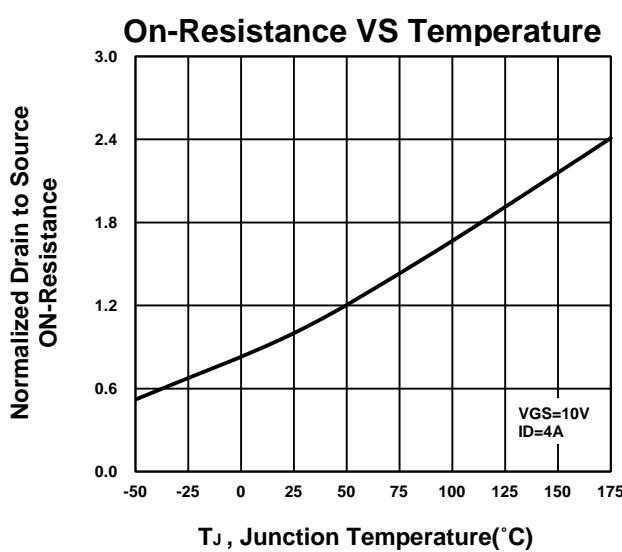
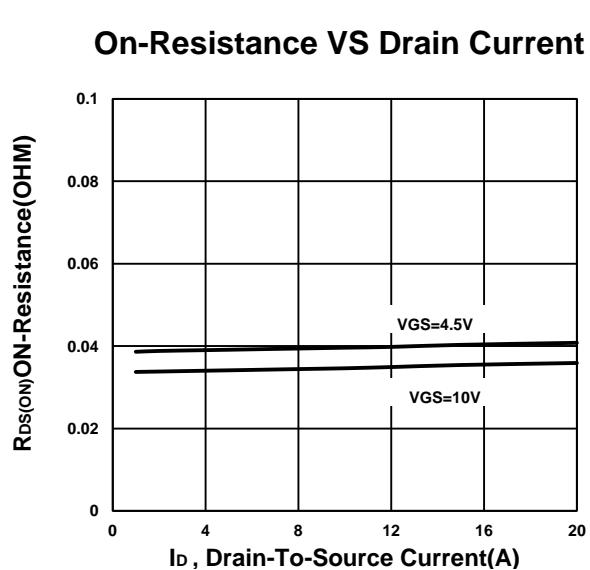
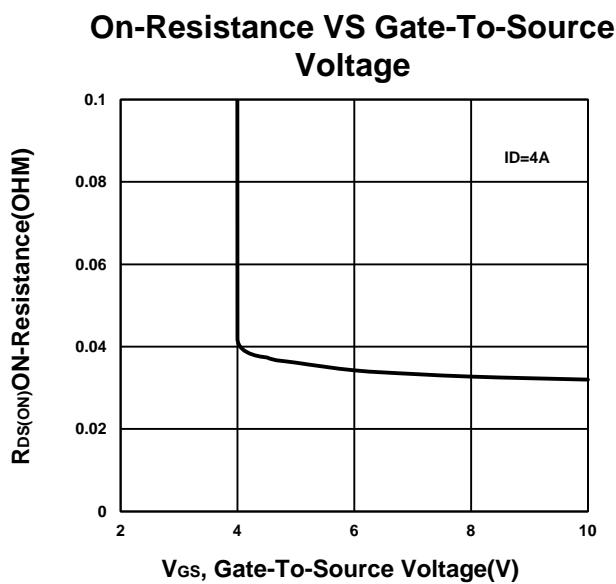
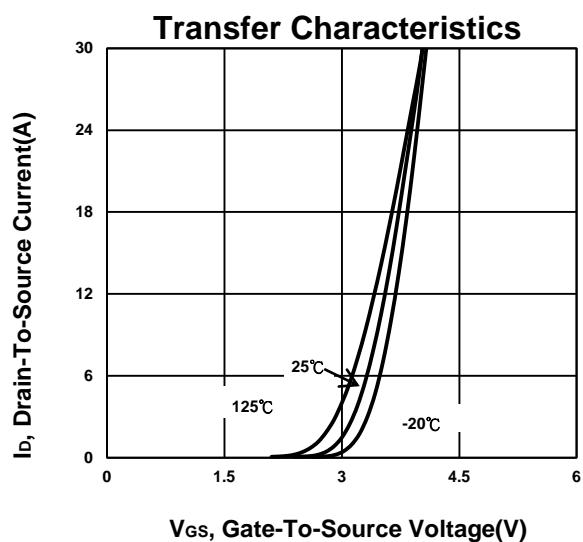
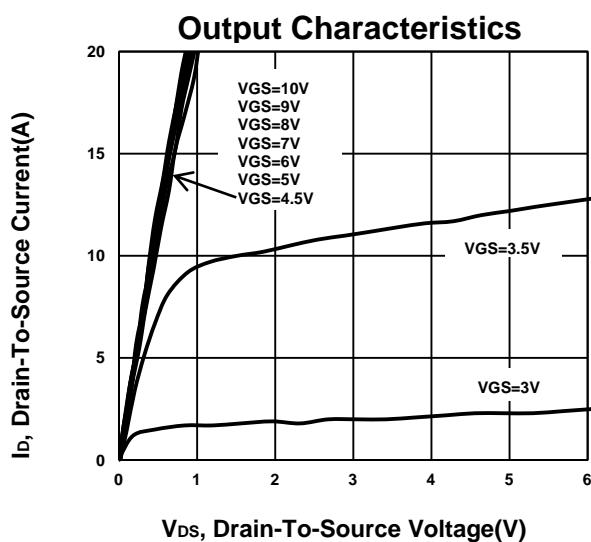
PARAMETER	SYMBOL	TEST CONDITIONS	LIMITS			UNIT
			MIN	TYP	MAX	
<b>STATIC</b>						
Drain-Source Breakdown Voltage	$V_{(\text{BR})\text{DSS}}$	$V_{\text{GS}} = 0\text{V}, I_D = 250\mu\text{A}$	150			V
Gate Threshold Voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{DS}} = V_{\text{GS}}, I_D = 250\mu\text{A}$	1	2.1	3	
Gate-Body Leakage	$I_{\text{GSS}}$	$V_{\text{DS}} = 0\text{V}, V_{\text{GS}} = \pm 20\text{V}$			$\pm 100$	nA
Zero Gate Voltage Drain Current	$I_{\text{DSS}}$	$V_{\text{DS}} = 150\text{V}, V_{\text{GS}} = 0\text{V}$			1	
		$V_{\text{DS}} = 150\text{V}, V_{\text{GS}} = 0\text{V}, T_J = 125^\circ\text{C}$			100	$\mu\text{A}$
Drain-Source On-State Resistance <sup>1</sup>	$R_{\text{DS}(\text{ON})}$	$V_{\text{GS}} = 10\text{V}, I_D = 4\text{A}$		34	45	
		$V_{\text{GS}} = 4.5\text{V}, I_D = 4\text{A}$		39	60	$\text{m}\Omega$
Forward Transconductance <sup>1</sup>	$g_{\text{fs}}$	$V_{\text{DS}} = 5\text{V}, I_D = 4\text{A}$		18		S
<b>DYNAMIC</b>						
Input Capacitance	$C_{\text{iss}}$	$V_{\text{GS}} = 0\text{V}, V_{\text{DS}} = 75\text{V}, f = 1\text{MHz}$		1169		pF
Output Capacitance	$C_{\text{oss}}$			97		
Reverse Transfer Capacitance	$C_{\text{rss}}$			15		
Gate Resistance	$R_g$	$V_{\text{GS}} = 0\text{V}, V_{\text{DS}} = 0\text{V}, f = 1\text{MHz}$		0.5		$\Omega$
Total Gate Charge <sup>2</sup>	$Q_g$	$V_{\text{GS}} = 10\text{V}$ $V_{\text{GS}} = 4.5\text{V}$		21		nC
				12		
Gate-Source Charge <sup>2</sup>	$Q_{\text{gs}}$	$V_{\text{DS}} = 75\text{V}, V_{\text{GS}} = 10\text{V}, I_D = 4\text{A}$		3.4		nC
Gate-Drain Charge <sup>2</sup>	$Q_{\text{gd}}$			6.3		
Turn-On Delay Time <sup>2</sup>	$t_{\text{d}(\text{on})}$			8		
Rise Time <sup>2</sup>	$t_r$			21		
Turn-Off Delay Time <sup>2</sup>	$t_{\text{d}(\text{off})}$	$V_{\text{DS}} = 75\text{V}, I_D \geq 4\text{A}, V_{\text{GS}} = 10\text{V}, R_{\text{GEN}} = 6\Omega$		23		nS
Fall Time <sup>2</sup>	$t_f$			28		
<b>SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS (<math>T_J = 25^\circ\text{C}</math>)</b>						
Continuous Current	$I_S$				24	A
Forward Voltage <sup>1</sup>	$V_{\text{SD}}$	$I_F = 4\text{A}, V_{\text{GS}} = 0\text{V}$			1.2	V
Reverse Recovery Time	$t_{\text{rr}}$	$I_F = 4\text{A}, dI_F/dt = 100\text{A}/\mu\text{s}$		67		nS
Reverse Recovery Charge	$Q_{\text{rr}}$			97		nC

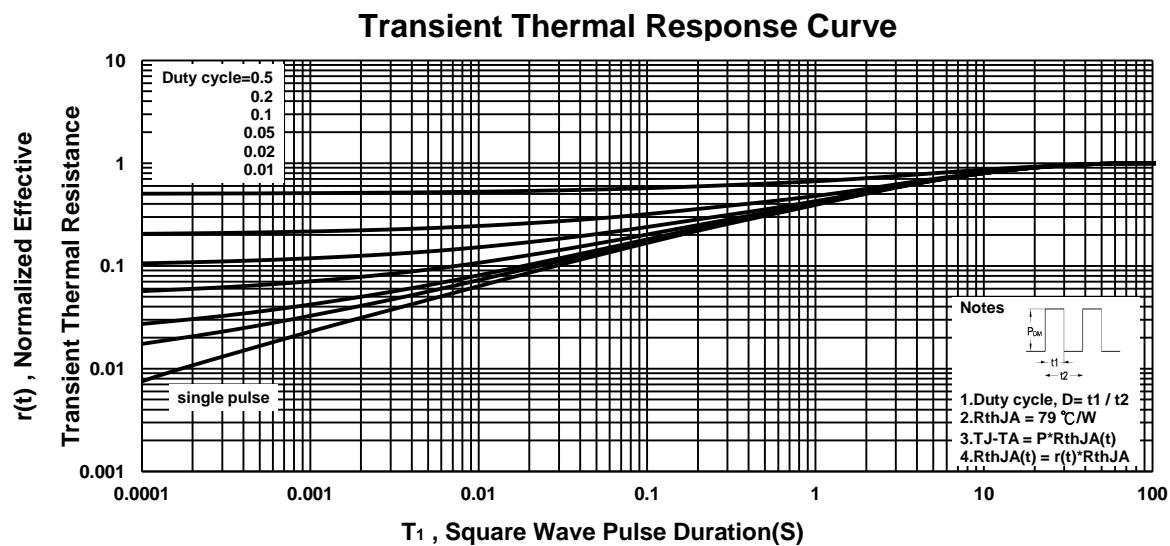
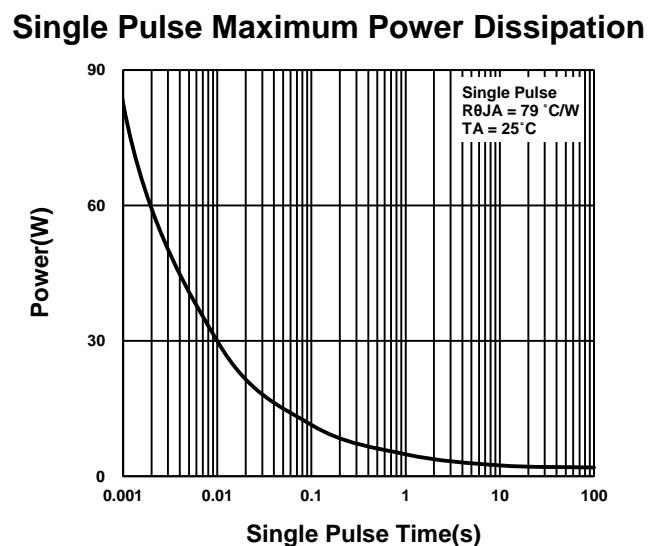
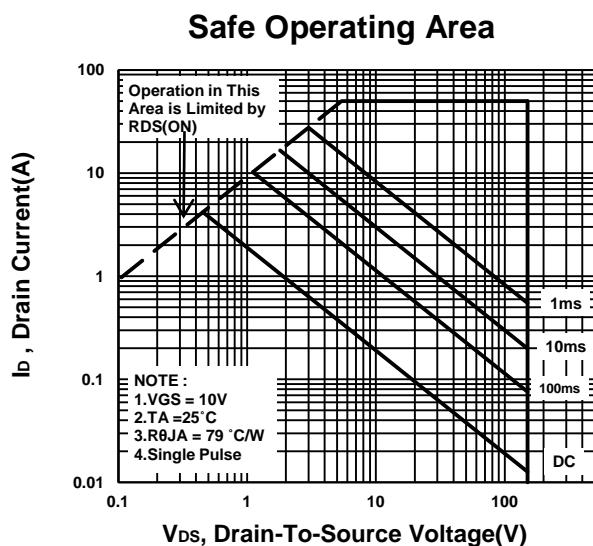
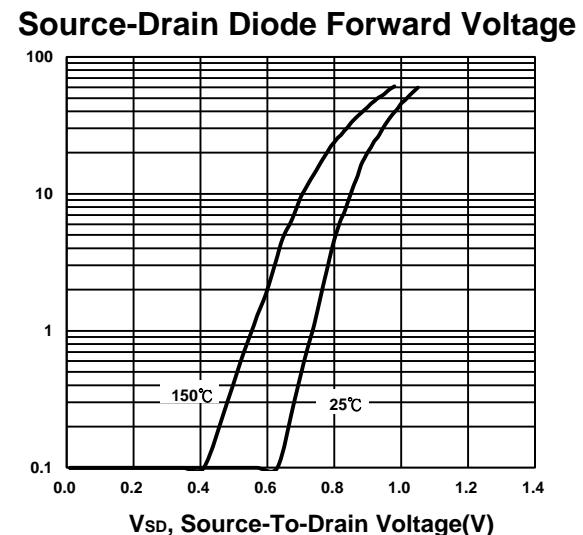
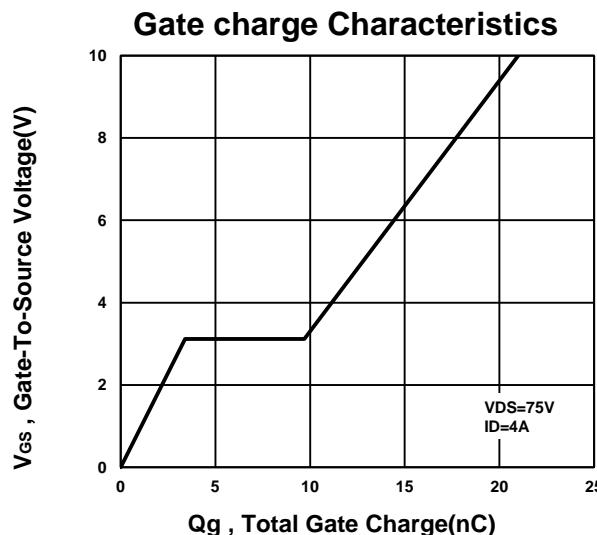
<sup>1</sup>Pulse test : Pulse Width  $\leq 300\ \mu\text{sec}$ , Duty Cycle  $\leq 2\%$ .<sup>2</sup>Independent of operating temperature.

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